

PATENT ASSIGNMENT COVER SHEET

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NATURE OF CONVEYANCE:	ASSIGNMENT		
CONVEYING PARTY DATA			
	Name	Execution Date	
	BO YANG	12/05/2012	
	ALEKSEI V. GERSHUN	09/27/2012	
	PETER M. WOYCIESJES	09/27/2012	
RECEIVING PARTY DATA			
Name:	PRESTONE PRODUCTS CORPORATION		
Street Address:	69 EAGLE ROAD		
City:	DANBURY		
State/Country:	CONNECTICUT		
Postal Code:	06810		
PROPERTY NUMBERS Total: 1			
	Property Type	Number	
	Application Number:	14639637	
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NAME OF SUBMITTER:	ERIN J. FOX		
SIGNATURE:	/Erin J. Fox/		
DATE SIGNED:	03/13/2015		
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ASSIGNMENT

WHEREAS I/WE, **Bo Yang** of **Ridgefield, CT** and a mailing address of **140 Bennetts Farm Rd, Ridgefield, CT 06877, US**; **Aleksei V. Gershun** of **Southbury, CT** and a mailing address of **69 Eagle Rd, Danbury, CT 06810 US**; and **Peter M. Woyciesjes** of **Woodbury, CT** and a mailing address of **69 Eagle Rd, Danbury, CT 06810, CT** (hereinafter referred to as "ASSIGNORS"); have invented certain new and useful improvements in U.S. Patent Application Serial No. 13/606,527 filed September 7, 2012 and entitled:

HEAT TRANSFER FLUID ADDITIVE COMPOSITION

WHEREAS, **Prestone Products Corporation**, (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the United States, having a place of business at **69 Eagle Road, Danbury, Connecticut 06810**, is desirous of acquiring an interest in the United States and all foreign countries, in and to the invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNORS, have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and I do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that I will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the

Serial No. 13/606,527
H0027856-3 (AO20236US)

United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 12/5/2012

Bo Yang L.S.
Bo Yang

Date: _____

Aleksei V. Gershun

Date: _____

Peter M. Woyciesjes

ASSIGNMENT

WHEREAS I/WE, **Bo Yang of Ridgefield, CT** and a mailing address of **140 Bennetts Farm Rd, Ridgefield, CT 06877, US**; **Aleksei V. Gershun of Southbury, CT** and a mailing address of **69 Eagle Rd, Danbury, CT 06810 US**; and **Peter M. Woyciesjes of Woodbury, CT** and a mailing address of **69 Eagle Rd, Danbury, CT 06810, CT** (hereinafter referred to as "ASSIGNORS"); have invented certain new and useful improvements in U.S. Patent Application Serial No. 13/606,527 filed September 7, 2012 and entitled:

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United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.


Date: _____

Bo Yang L.S.

Date: 09/27/2012


Aleksei V. Gershun L.S.

Date: 09/27/2012


Peter M. Woyciesjes L.S.